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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10083585	FILING DATE 02/27/2002	CLASS 438	SUBCL/1.3	GAU 2879 2812	EXAMINER
**APPLICANTS: Iwasaki Yukiko; Shoji Tatsumi; Nishida Shoji;					
**CONTINUING DATA VERIFIED: None AKS					
** FOREIGN APPLICATIONS VERIFIED: Yes AKS JAPAN 076284/2001(PAT.) 03/16/2001 JAPAN 029299/2002(PAT.) 02/06/2002					
PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>			
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiner's initials		<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> yes <input type="checkbox"/> no AKS	ATTORNEY DOCKET NO 03560.002998		
TITLE : Method for manufacturing a semiconductor film					
U.S.DEP.T. OF COMM./PAT & TM-PTO-436L(Rev 12-94)					

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G
ISSUE FEE		DRAWING		
Amount Due	Date Paid	Sheets Drwg.		Figs.Drwg.
				Print Fig.
TERMINAL DISCLAIMER		Application Examiner		
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